

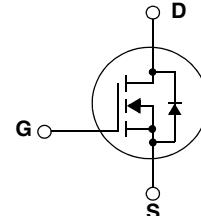
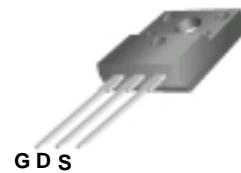


WFF5N60

600V N-Channel MOSFET

Features

- Low Intrinsic Capacitances
- Excellent Switching Characteristics
- Extended Safe Operating Area
- Unrivalled Gate Charge : 15 nC (Typ.)
- BVDSS=600V, ID=4.5A
- Lower $R_{DS(on)}$: 2.5Ω (Max) @VG=10V
- 100% Avalanche Tested



TO-220F

G-Gate,D-Drain,S-Source

Absolute Maximum Ratings $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	WFF5N60	Units
V_{DSS}	Drain-Source Voltage	600	V
I_D	Drain Current -continuous ($T_c=25^\circ C$)	4.5*	A
	-continuous ($T_c=100^\circ C$)	1.8*	A
V_{GS}	Gate-Source Voltage	± 30	V
E_{AS}	Single Plused Avalanche Energy (Note1)	240	mJ
I_{AR}	Avalanche Current (Note2)	4	A
P_D	Power Dissipation ($T_c=25^\circ C$)	100	W
T_J, T_{STG}	Operating and Storage Temperature Range	-55 ~ +150	°C
T_L	Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds	300	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max	Units
$R_{\theta JC}$	Thermal Resistance,Junction to Case	--	3.13	°C/W
$R_{\theta JA}$	Thermal Resistance,Junction to Ambient	--	62.5	°C/W

* Drain current limited by maximum junction temperature.

Electrical Characteristics $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ.	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$ID=250 \mu A, VGS=0$	600	--	--	V
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D=250 \mu A, Reference to 25^\circ C$	--	0.6	--	V/ $^\circ C$
$IDSS$	Zero Gate Voltage Drain Current	$V_{DS}=600V, V_{GS}=0V$	--	--	10	μA
		$V_{DS}=480V, T_c=125^\circ C$			100	μA
IG_{SSF}	Gate-body leakage Current, Forward	$V_{GS}=+30V, V_{DS}=0V$	--	--	100	nA
IG_{SSR}	Gate-body leakage Current, Reverse	$V_{GS}=-30V, V_{DS}=0V$	--	--	-100	nA

On Characteristics

$V_{GS(th)}$	Date Threshold Voltage	$I_D=250\mu A, V_{DS}=V_{GS}$	2	--	4	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$I_D=2A, V_{GS}=10V$	--	--	2.5	Ω

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS}=25V, V_{GS}=0, f=1.0MHz$	--	560	730	pF
C_{oss}	Output Capacitance		--	80	100	pF
C_{rss}	Reverse Transfer Capacitance		--	9	12	pF

Switching Characteristics

$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=300V, ID=4.5A$ $RG=25\Omega$ (Note 3,4)	--	13	35	nS
T_r	Turn-On Rise Time		--	45	100	nS
$T_{d(off)}$	Turn-Off Delay Time		--	35	80	nS
T_f	Turn-Off Fall Time		--	40	90	nS
Q_g	Total Gate Charge	$V_{DS}=480, V_{GS}=10V, ID=4.5A$ (Note 3,4)	--	16	20	nC
Q_{gs}	Gate-Source Charge		--	3.5	--	nC
Q_{gd}	Gate-Drain Charge			7.8	--	nC

Drain-Source Diode Characteristics and Maximum Ratings

I_s	Maximum Continuous Drain-Source Diode Forward Current	--	--	4.5	A
I_{SM}	Maximum Plused Drain-Source DiodeForward Current	--	--	18	A
V_{SD}	Drain-Source Diode Forward Voltage	$I_D=4.5A$	--	--	1.5 V
t_{rr}	Reverse Recovery Time	$I_s=4.5A, V_{GS}=0V$	--	270	-- nS
Q_{rr}	Reverse Recovery Charge	$dI_F/dt=100A/\mu s$ (Note3)	--	1.9	-- μC

*Notes 1, $L=21.7mH, I_{AS}=4.5A, V_{DD}=50V, RG=25\Omega$, Starting $T_J=25^\circ C$

2, Repetitive Rating : Pulse width limited by maximum junction temperature

3, Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$

4, Essentially Independent of Operating Temperature

Typical Characteristics

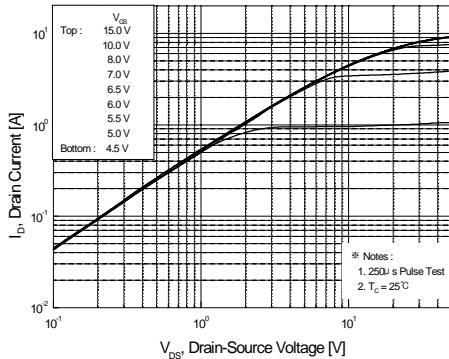


Figure 1. On-Region Characteristics

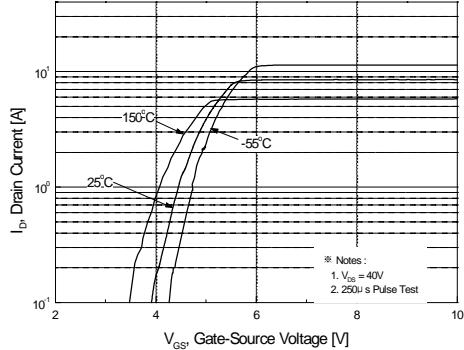


Figure 2. Transfer Characteristics

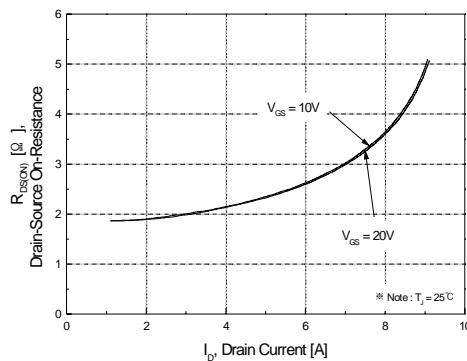


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

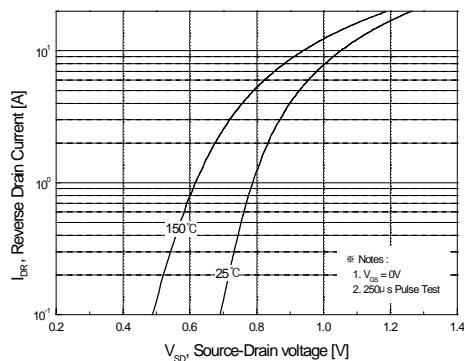


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

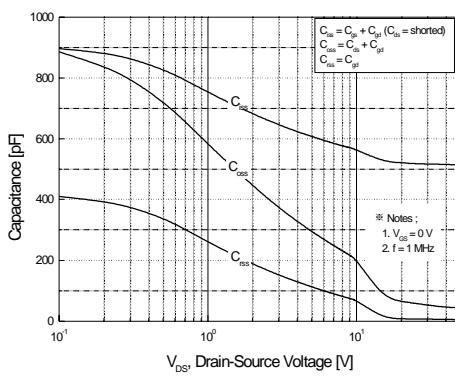


Figure 5. Capacitance Characteristics

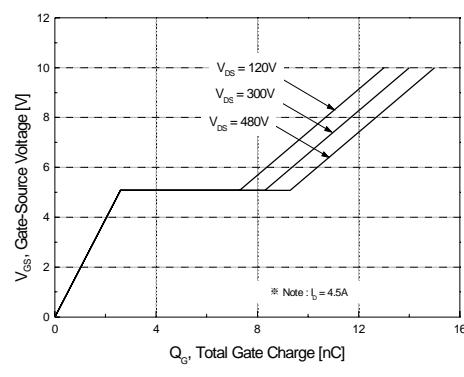
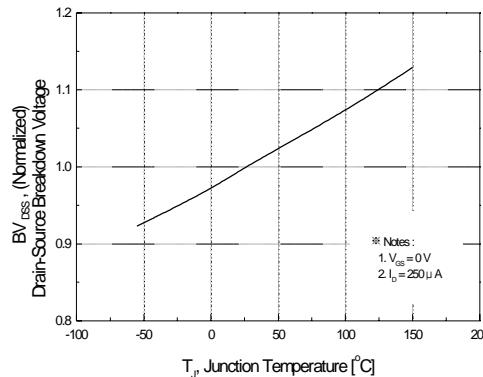
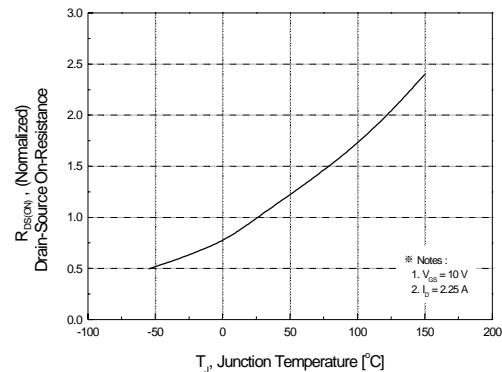


Figure 6. Gate Charge Characteristics

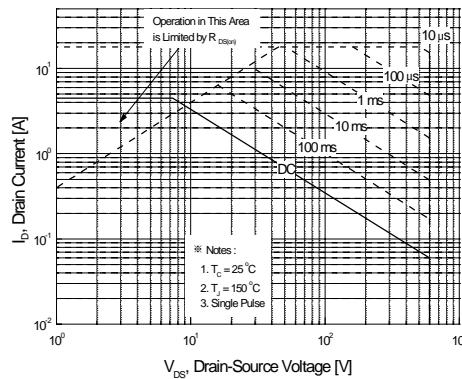
Typical Characteristics (Continued)



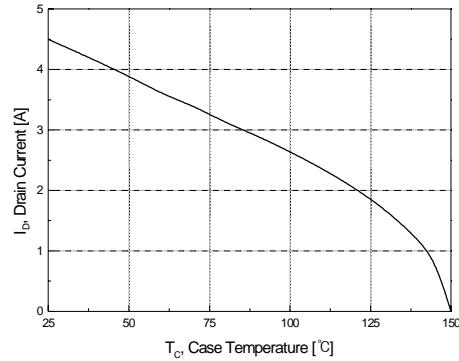
**Figure 7. Breakdown Voltage Variation
vs Temperature**



**Figure 8. On-Resistance Variation
vs Temperature**



**Figure 9-2. Maximum Safe Operating Area
for WFF5N60**



**Figure 10. Maximum Drain Current
vs Case Temperature**

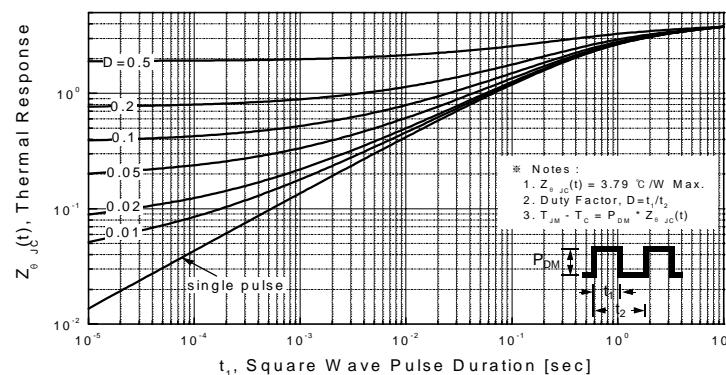
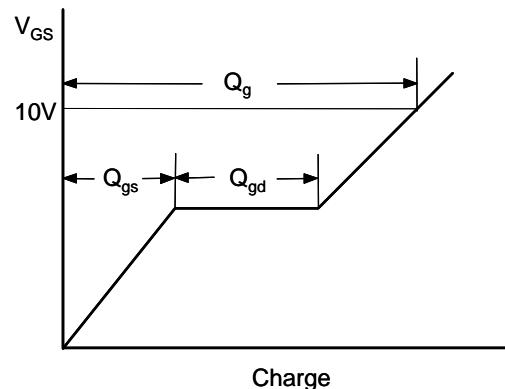
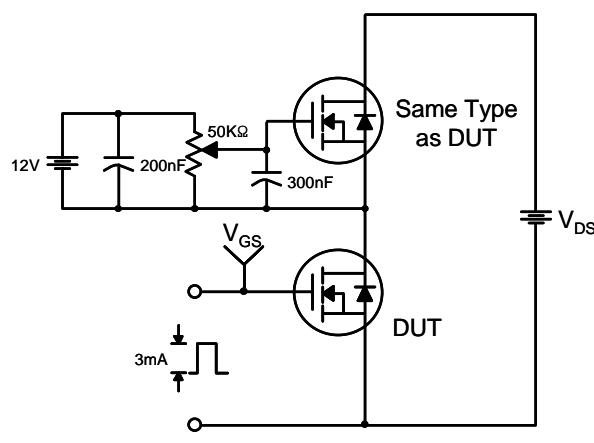
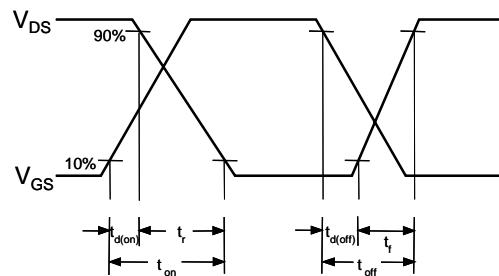
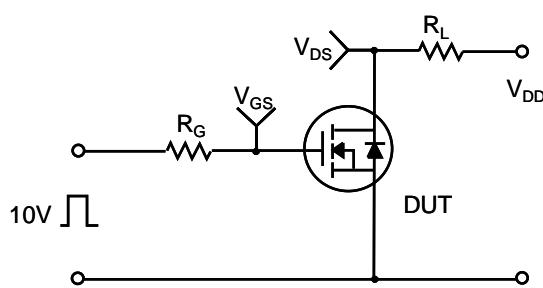
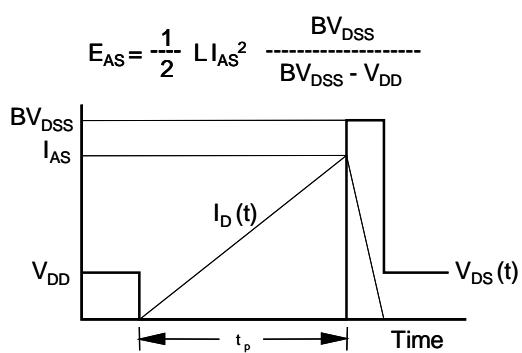
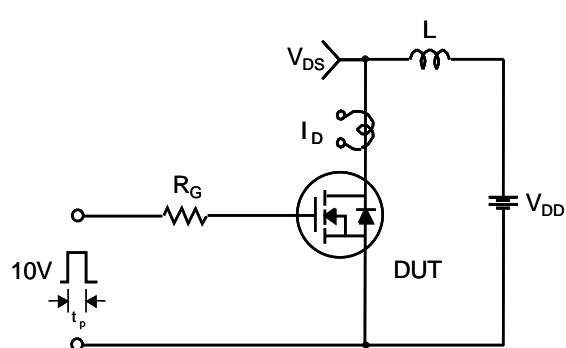


Figure 11-2. Transient Thermal Response Curve for WFF5N60

Gate Charge Test Circuit & Waveform

Resistive Switching Test Circuit & Waveforms

Unclamped Inductive Switching Test Circuit & Waveforms


Peak Diode Recovery dv/dt Test Circuit & Waveforms

